

# Low Quiescent Current Low-Dropout Linear Voltage Regulator

#### **DESCRIPTION**

TS3480 series is an integrated linear voltage regulator. It can be provided the operation from an input as high as 30V and a guaranteed maximum dropout of 1.2V at the full 100mA load. The 1.2V quasi low dropout of TS3480 series is able to makes them a nice fit in many applications where the 2 to 2.5V dropout of TS78LXX series devices precludes their use.

The TS3480 series features 5V & 3.3V output voltage options. The SOT packaging and quasi low dropout features of the TS3480 series converge in this device to provide a very nice, very tiny 5V & 3.3V, 100mA bias supply that regulates directly off the system power supply.

#### **FEATURES**

- 30V maximum input for operation
- 2V guaranteed maximum dropout over full load and temperature ranges
- 100mA guaranteed minimum load current
- ±5% guaranteed output voltage tolerance over full load and temperature ranges
- -40 to +125°C junction temperature range for operation
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC.
- Halogen-free according to IEC 61249-2-21

#### **APPLICATION**

- Tiny alternative to TS78LXX series and similar devices
- Tiny 5V±5% to 3.3V, 100mA converter
- Post regulator for switching DC/DC converter
- Bias supply for analog circuits



SOT-23

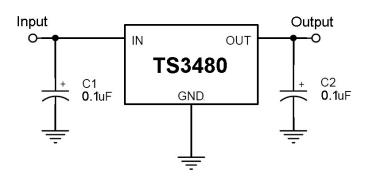


#### Pin Definition:

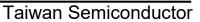
- 1. Output
- 2. Input
- 3. Ground

Notes: MSL 1 (Moisture Sensitivity Level) per J-STD-020

#### TYPICAL APPLICATION CIRCUIT



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ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise specified) (Note 1)							
PARAMETER	SYMBOL	LIMIT	UNIT				
Input Voltage	V <sub>IN</sub>	35	V				
Operating Input Voltage	V <sub>OPER</sub>	30	V				
Output Current Range	I <sub>OUT</sub>	100	mA				
Power Dissipation (Note 2)	P <sub>D</sub>	350	mW				
Junction Temperature	TJ	+150	°C				
Operating Temperature Range	T <sub>OPER</sub>	-40 ~ +125	°C				
Storage Temperature Range	T <sub>STG</sub>	-65 ~ +150	°C				
Lead Soldering Time (260°C) (Note 3)	T <sub>SOLDER</sub>	4	Sec				
ESD (note 4)	НВМ	2	kV				

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
3.3V Output						
Output Voltage	V <sub>OUT</sub>	V <sub>IN</sub> = 4.8V, lo= 1mA ~ 100mA	3.17	3.3	3.43	V
Line Regulation	$\Delta V_{ extsf{DDLine}}$	$4.8V \le V_{IN} \le 30V$ , Io= 1mA		10	25	mV
Load Regulation	$\Delta V_{DDLoad}$	V <sub>IN</sub> = 4.8V, lo= 1mA~100mA		20	40	mV
Dropout Voltage	.,	lo=10mA		0.75	0.9	V
	V <sub>DROP_OUT</sub>	lo=100mA		0.95	1.1	V
Quiescent Current		$V_{IN} = 4.8V \le V_{IN} \le 30V$ , Io=0V		3	5	mA
Output Current	I <sub>OUT</sub>	V <sub>IN</sub> - V <sub>OUT</sub> = 20V	100			mA
Ripple Rejection		F= 10Hz ~ 100kHz, Io= 0mA, $C_{OUT} = 0.1\mu F$ , $V_{IN} = 10V$		100		μV <sub>RMS</sub>
5.0V Output	·					
Output Voltage	V <sub>OUT</sub>	V <sub>IN</sub> = 6.5V, lo= 1mA ~ 100mA	4.80	5.0	5.20	V
Line Regulation	$\Delta V_{ extsf{DDLine}}$	$6.5V \le V_{IN} \le 30V$ , Io= 1mA		10	25	mV
Load Regulation	$\Delta V_{DDLoad}$	V <sub>IN</sub> = 6.5V, lo= 10mA~100mA		20	40	mV
Dropout Voltage	.,	lo=10mA		0.75	0.9	V
	$V_{DROP\_OUT}$	lo=100mA		0.95	1.1	V
Quiescent Current		$V_{IN} = 6.5V \le V_{IN} \le 30V, Io=0V$		3	5	mA
Output Current	I <sub>OUT</sub>	V <sub>IN</sub> - V <sub>OUT</sub> = 20V	100			mA
Ripple Rejection		F= $10$ Hz ~ $100$ kHz, Io= $0$ mA, C <sub>OUT</sub> = $0.1$ µF, V <sub>IN</sub> = $10$ V		150		μVrms



## Taiwan Semiconductor

#### Note:

- Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating ratings are conditions
  under which operation of the device is guaranteed. Operating ratings do not imply guaranteed performance limits. For
  guaranteed performance limits and associated test conditions, see the Electrical Characteristics.
- 2. The Absolute Maximum power dissipation depends on the ambient temperature and can be calculated using  $P = (T_J T_A) / R_{\theta JA}$  where  $T_J$  is the junction temperature, Ta is the ambient temperature, and  $R_{\theta JA}$  is the junction-to-ambient thermal resistance. The 350mW rating results from substituting the absolute maximum junction temperature, 150°C for  $T_J$ , 50°C for  $T_A$ , and 300°C/W for  $R_{\theta JA}$ . More power can be safely dissipated at lower ambient temperatures, and less power can be safely dissipated at higher ambient temperatures. The absolute maximum power dissipation can be increased by 3.5mW for each Celsius below 50°C ambient. It must be derated by 3.5mW for each Celsius above 50°C ambient. A  $R_{\theta JA}$  of 300°C/W represents the worst-case condition of no heat sinking of the 3-lead plastic SOT-23 package. Heat sinking enables the safe dissipation of more power. The TS3480 actively limits its junction temperature to about 150°C.
- 3. Times shown are dwell times. Temperatures shown are dwell temperatures.
- 4. For testing purposes, ESD was applied using the Human-Body Model, a 100pF capacitor discharged through a  $1.5k\Omega$  resistor
- 5. A typical is the center of characterization data taken with T<sub>A</sub> =T<sub>J</sub> = 25°C. Typical are not guaranteed.
- 6. All limits are guaranteed. All electrical characteristics having room-temperature limits are tested during production with  $T_A$  = $T_J$  = 25°C. All hot and cold limits are guaranteed by correlating the electrical characteristics to process and temperature variations and applying statistical process control.
- 7. All voltages except dropout are with respect to the voltage at the GND pin.

#### ORDERING INFORMATION

OUTPUT VOLTAGE	ORDERING CODE	PACKAGE	PACKING
3.3V	TS3480CX33 RFG	SOT-23	3,000pcs / 7" Reel
5V	TS3480CX50 RFG	SOT-23	3,000pcs / 7" Reel

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#### **CHARACTERISTICS CURVES**

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

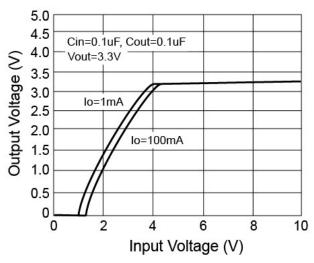


Figure 1. Output Voltage vs. Input Voltage

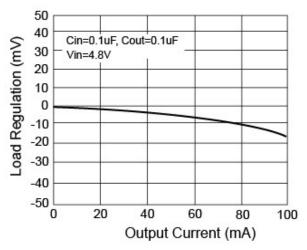


Figure 3. Load Regulation

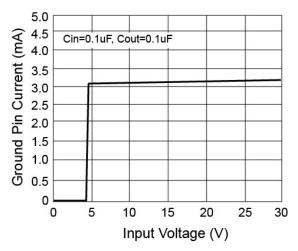


Figure 5. Ground Pin Current vs. Input Voltage

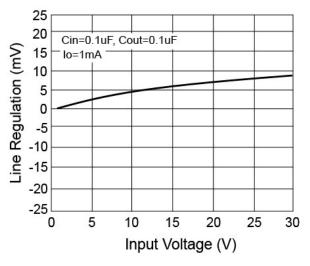


Figure 2. Line Regulation

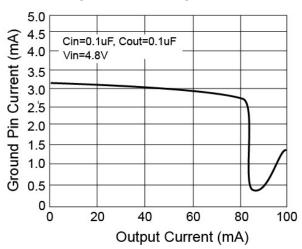


Figure 4. Ground Pin Current vs. Output Current

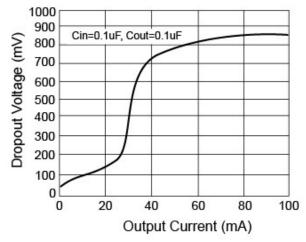
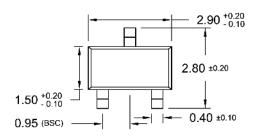


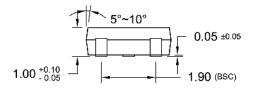
Figure 6. Dropout Voltage vs. Load Current

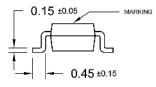


## PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

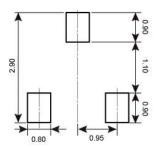
#### **SOT-23**







## SUGGESTED PAD LAYOUT (Unit: Millimeters)



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### **MARKING DIAGRAM**



M = Device Code

x = Voltage Code (5=5V, S=3.3V)

Y = Year Code

**M** = Month Code for Halogen Free Product

 $\mathbf{O}$  =Jan  $\mathbf{P}$  =Feb  $\mathbf{Q}$  =Mar  $\mathbf{R}$  =Apr

S =May T =Jun U =Jul V =Aug

W = Sep X = Oct Y = Nov Z = Dec

**L** = Lot Code (1~9, A~Z)



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